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(12) **United States Design Patent**
Ferren

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(45) **Date of Patent:** **** Dec. 15, 2015**

(54) **COMPUTING DEVICE WITH SENSOR**

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(US)

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(73) Assignee: **Intel Corporation**, Santa Clara, CA
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(**) Term: **14 Years**

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(21) Appl. No.: **29/450,316**

Saitek Obsidian 1000 dpi Wireless Rechargeable Optical Mouse, announced Oct. 7, 2008 [online], [site visited Sep. 18, 2014] Available from Internet, URL: <<http://www.amazon.com/gp/product/B000K4TWIM>>.

(22) Filed: **Mar. 15, 2013**

Non-Final Office Action received for U.S. Appl. No. 12/646,220, mailed on Jul. 19, 2012.

(51) **LOC (10) Cl.** **14-02**

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(52) **U.S. Cl.**

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USPC **D14/341**

(Continued)

(58) **Field of Classification Search**

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D14/203.7, 129, 130, 147, 218, 247, 248,
D14/250, 385, 388, 389, 315-318, 420, 426,
D14/439; D10/65, 104.1; D18/6, 7;
D21/324, 329, 330, 332; 455/556.1,
455/556.2, 566, 575.1, 90.3; 379/433.04,
379/433.01, 433.06, 916; 345/173, 901,
345/905; 361/679.26, 679.27, 679.3,
361/679.55, 679.56; D6/308, 310; 463/37;
248/917-924; 348/376; D11/222
CPC A63H 33/3016; G06F 1/1613; H04M
1/0202; H04M 1/0279; H04M 1/0281; H04M
1/0283

See application file for complete search history.

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(74) *Attorney, Agent, or Firm* — Patent Capital Group

(57) **CLAIM**

The ornamental design for a computing device with sensor, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view illustrating a computing device with sensor according to my new design;
FIG. 2 is a front view thereof;
FIG. 3 is a back view thereof;
FIG. 4 is a side view thereof;
FIG. 5 is another side view thereof;
FIG. 6 is a top view thereof; and,
FIG. 7 is a bottom view thereof.

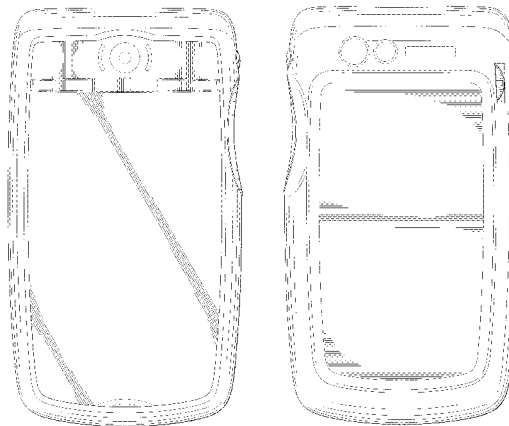
The broken lines represent portions of the computing device with sensor and form no part of the claimed design. The unshaded regions bounded by broken lines illustrate boundaries that form no part of the claimed design. Non-oblique line shading is meant to show contour and not surface ornamentation.

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1 Claim, 5 Drawing Sheets



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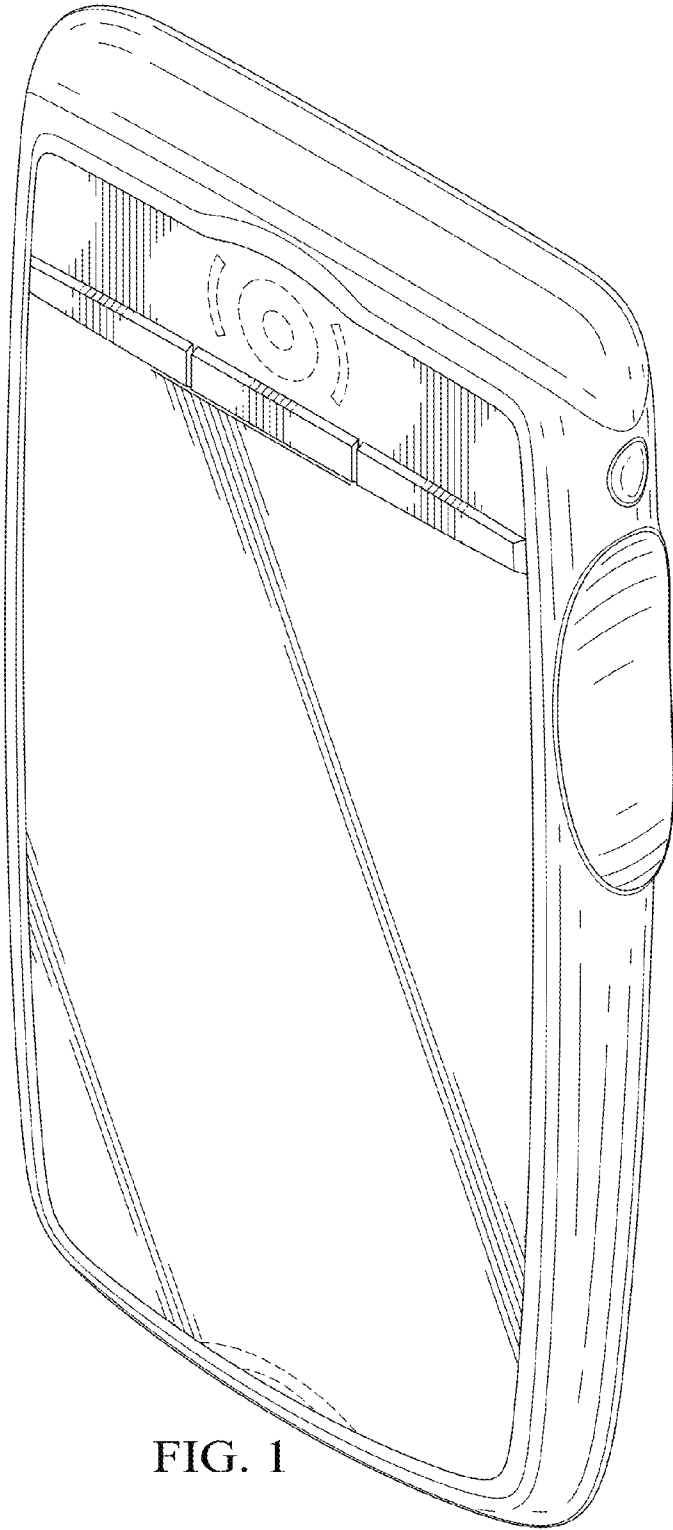


FIG. 1

FIG. 2

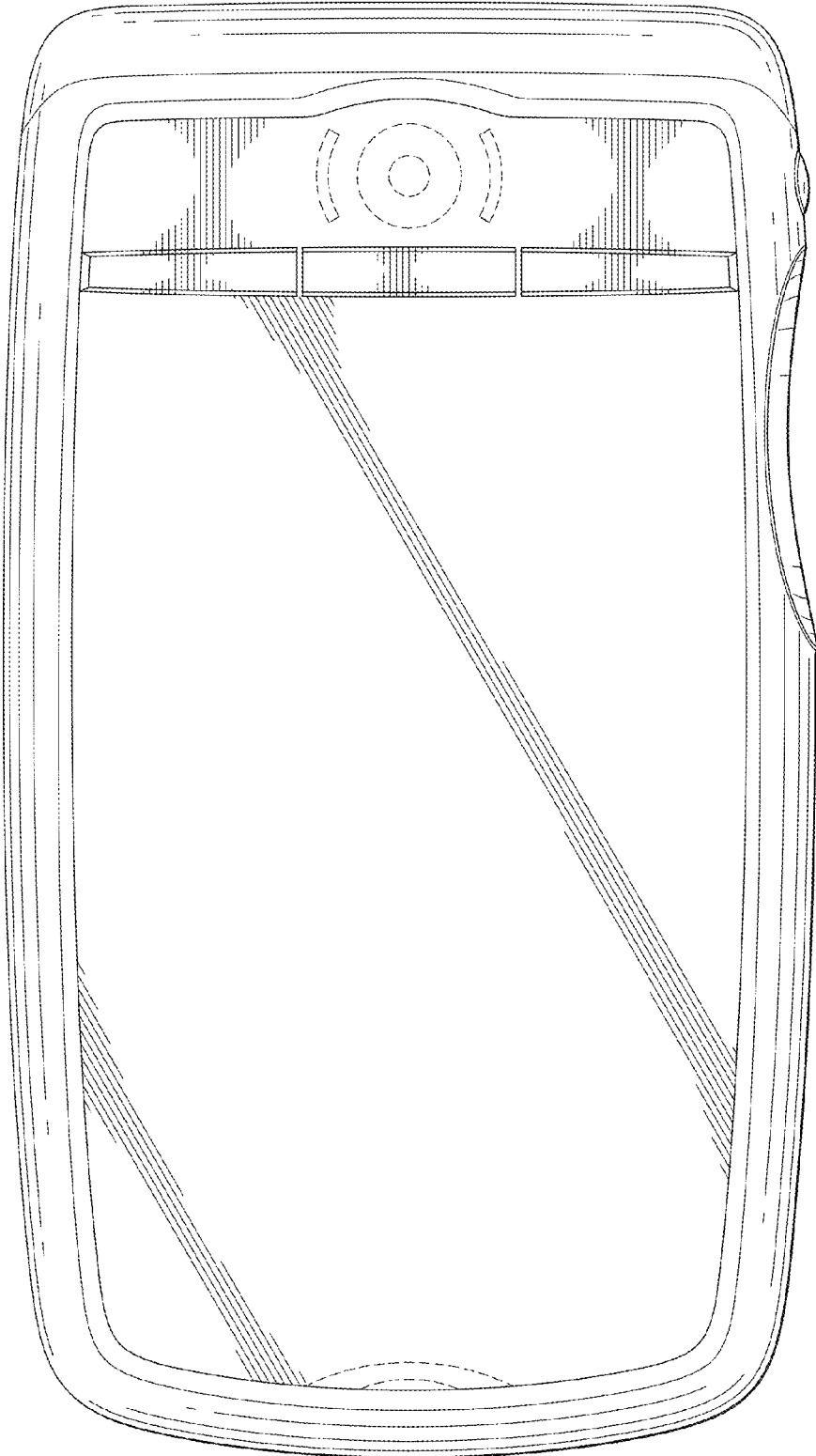


FIG. 3

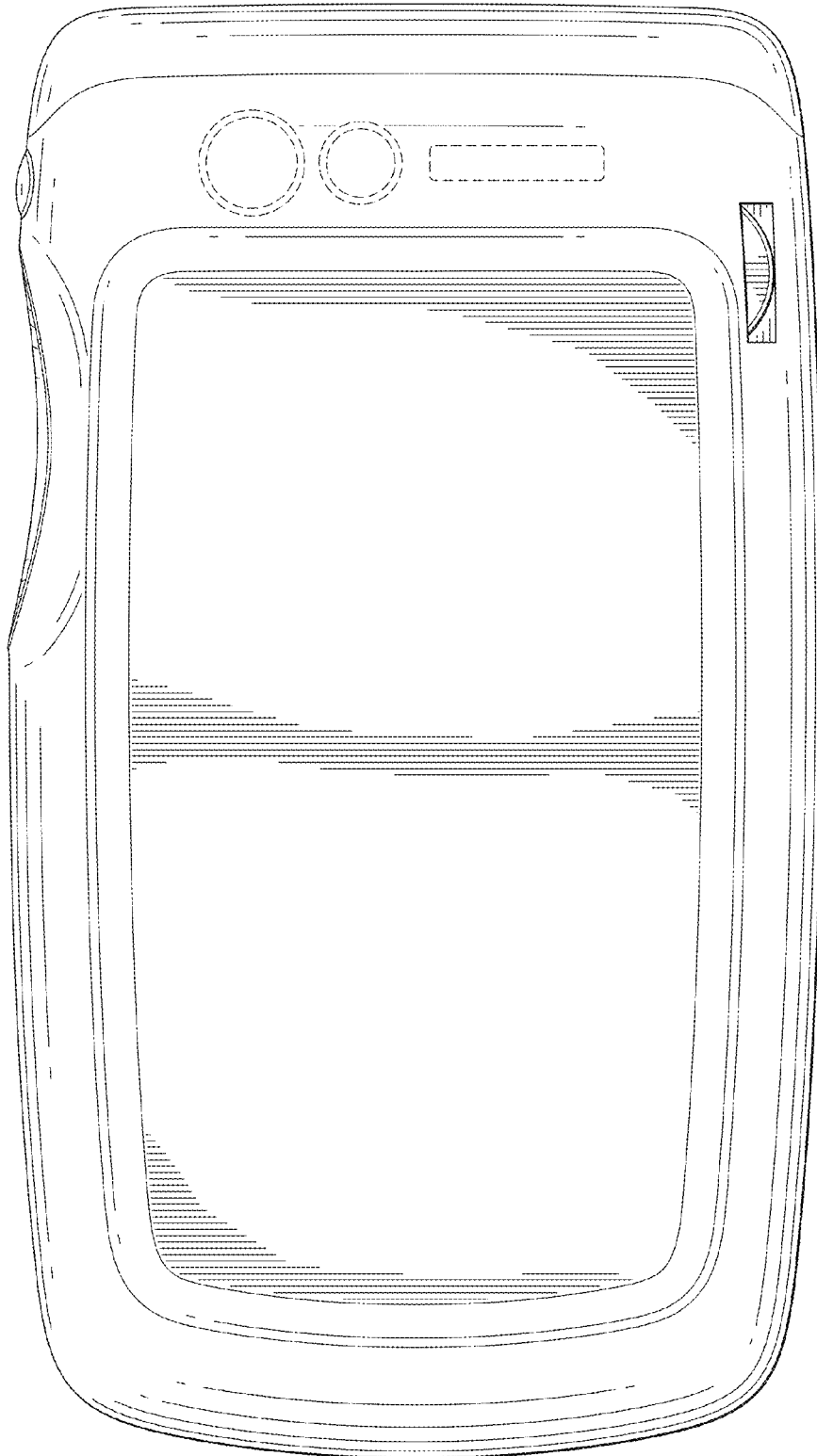


FIG. 4

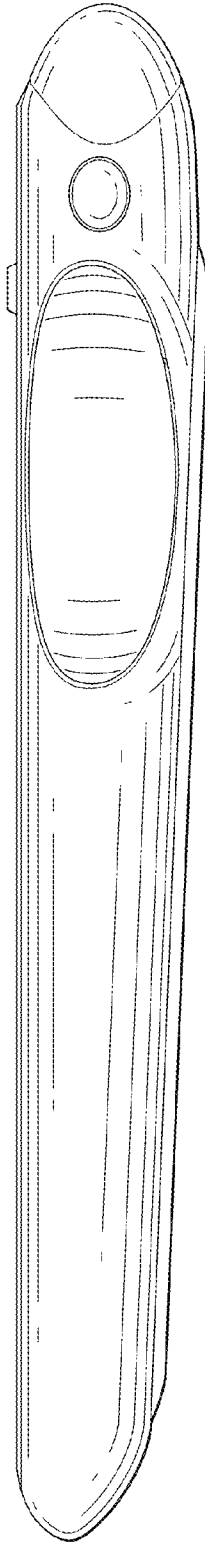
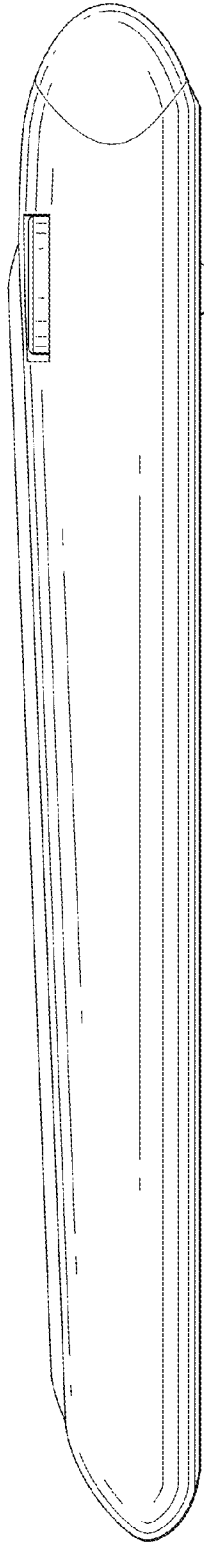


FIG. 5



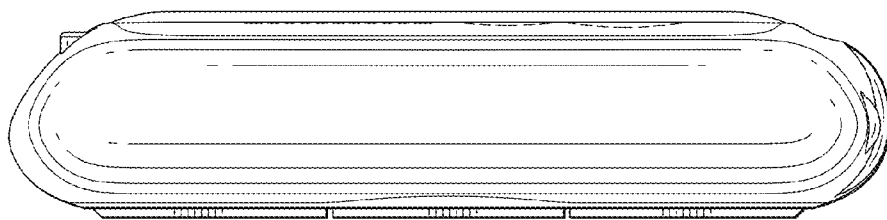


FIG. 6

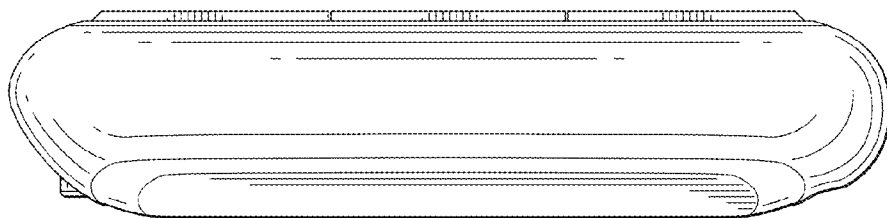


FIG. 7